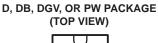
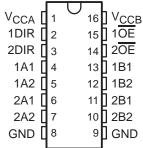
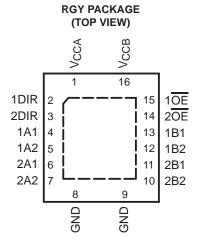
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- Control Inputs V<sub>IH</sub>/V<sub>IL</sub> Levels are Referenced to V<sub>CCA</sub> Voltage
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation







#### description/ordering information

This 4-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVC4T245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVC4T245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V<sub>CCA</sub>

This device is fully specified for partial-power-down applications using l<sub>off</sub>. The l<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

#### ORDERING INFORMATION

TA	PACKA	AGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	QFN – RGY	Tape and reel	SN74AVC4T245RGYR	
	SOIC - D	Tube	SN74AVC4T245D	
	SOIC - D	Tape and reel	SN74AVC4T245DR	
-40°C to 85°C	SSOP – DB	Tape and reel	SN74AVC4T245DBR	
	TOCOD DW	Tube	SN74AVC4T245PW	
	TSSOP – PW	Tape and reel	SN74AVC4T245PWR	
	TVSOP – DGV Tape and reel		SN74AVC4T245DGVR	

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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### description/ordering information (continued)

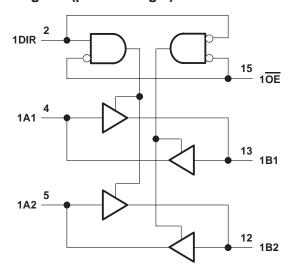
The V<sub>CC</sub> isolation feature ensures that if either V<sub>CC</sub> input is at GND, then both ports are in the high-impedance state.

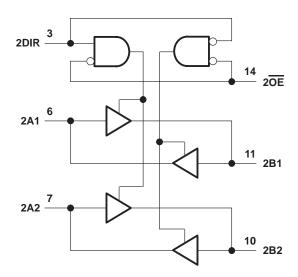
To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### **FUNCTION TABLE** (each 4-bit section)

INP	UTS	
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Χ	Isolation

### logic diagram (positive logic)





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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CCA</sub> and V <sub>CCB</sub> Input voltage range, V <sub>I</sub> (see Note 1): I/O ports (A port)  I/O ports (B port)  Control inputs	-0.5 V to 4.6 V -0.5 V to 4.6 V
Voltage range applied to any output in the high-impedance or power-off state, V <sub>O</sub>	
(see Note 1): (A port)	-0.5 V to 4.6 V
(B port)	-0.5~V to 4.6 $V$
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2): (A port)	
(B port)	o V <sub>CCB</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–50 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Continuous output current, I <sub>O</sub>	±50 mA
Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND	±100 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 3): D package	73°C/W
(see Note 3): DB package	82°C/W
(see Note 3): DGV package	120°C/W
(see Note 3): PW package	108°C/W
(see Note 4): RGY package	39°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.
- 4. The package thermal impedance is calculated in accordance with JESD 51-5.



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#### recommended operating conditions (see Notes 5 through 7)

			VCCI	vcco	MIN	MAX	UNIT
VCCA	Supply voltage				1.2	3.6	V
V <sub>CCB</sub>	Supply voltage				1.2	3.6	V
		<b>5</b>	1.2 V to 1.95 V		V <sub>CCI</sub> ×0.65		
VIН	High-level input voltage	Data inputs (see Note 8)	1.95 V to 2.7 V		1.6		V
	voltage	(300 14010 0)	2.7 V to 3.6 V		2		
		<b>5</b>	1.2 V to 1.95 V			V <sub>CCI</sub> × 0.35	
٧ <sub>IL</sub>	Low-level input voltage	Data inputs (see Note 8)	1.95 V to 2.7 V			0.7	V
	voltago	(000 11010 0)	2.7 V to 3.6 V			0.8	
		DIR	1.2 V to 1.95 V		V <sub>CCA</sub> × 0.65		
VIН	High-level input voltage	(Referenced to V <sub>CCA</sub> )	1.95 V to 2.7 V		1.6		V
	voltage	(see Note 9)	2.7 V to 3.6 V		2		
		DIR	1.2 V to 1.95 V			V <sub>CCA</sub> × 0.35	
VIL	Low-level input voltage	(Referenced to V <sub>CCA</sub> )	1.95 V to 2.7 V			0.7	V
	voltage	(see Note 9)	2.7 V to 3.6 V			0.8	
٧ <sub>I</sub>	Input voltage				0	3.6	V
\/ -	Output valtage	Active state			0	Vcco	V
VO	Output voltage	3-state			0	3.6	V
				1.2 V		-3	
				1.4 V to 1.6 V		-6	
lOH	High-level output curre	nt		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
lOL	Low-level output currer	nt		1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
Δt/Δν	Input transition rise or f	all rate				5	ns/V
TA	Operating free-air temp	perature			-40	85	°C

NOTES: 5.  $V_{CCI}$  is the  $V_{CC}$  associated with the data input port.

- 6. V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.
- 7. All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
- 8. For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH(min)</sub> = V<sub>CCI</sub> x 0.7 V, V<sub>IL(max)</sub> = V<sub>CCI</sub> x 0.3 V.
   9. For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH(min)</sub> = V<sub>CCA</sub> x 0.7 V, V<sub>IL(max)</sub> = V<sub>CCA</sub> x 0.3 V.



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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Notes 10 and 11)

				.,	.,	T,	\ = 25°C	;	-40°C to	85°C	
PARA	METER	TEST CONDITI	ONS	VCCA	VCCB	MIN	TYP	MAX	MIN	MAX	UNIT
		I <sub>OH</sub> = -100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V				VCCO-0.	2 V	
		$I_{OH} = -3 \text{ mA}$	1	1.2 V	1.2 V		0.95				
.,		$I_{OH} = -6 \text{ mA}$	],, ,,	1.4 V	1.4 V				1.05		.,
VOH		$I_{OH} = -8 \text{ mA}$	$V_I = V_{IH}$	1.65 V	1.65 V				1.2		V
		$I_{OH} = -9 \text{ mA}$		2.3 V	2.3 V				1.75		
		$I_{OH} = -12 \text{ mA}$		3 V	3 V				2.3		
		I <sub>OL</sub> = 100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	
		$I_{OL} = 3 \text{ mA}$		1.2 V	1.2 V		0.25				
V		$I_{OL} = 6 \text{ mA}$		1.4 V	1.4 V					0.35	V
VOL		$I_{OL} = 8 \text{ mA}$	VI = VIL	1.65 V	1.65 V					0.45	V
		$I_{OL} = 9 \text{ mA}$		2.3 V	2.3 V					0.55	
		$I_{OL} = 12 \text{ mA}$		3 V	3 V					0.7	
Ц	DIR input	$V_I = V_{CCA}$ or GND		1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μΑ
	A or B	V V 0.00V		0 V	0 to 3.6 V		±0.1	±1		±5	
loff	port	$V_I$ or $V_O = 0$ to 3.6 V		0 to 3.6 V	0 V		±0.1	±1		±5	μΑ
l <sub>OZ</sub> †	A or B port	$V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND	OE = VIH	3.6 V	3.6 V		±0.5	±2.5		±5	μΑ
	-			1.2 V to 3.6 V	1.2 V to 3.6 V						
ICCA		$V_I = V_{CCI}$ or GND	$I_O = 0$	0 V	3.6 V						μΑ
				3.6 V	0 V						
				1.2 V to 3.6 V	1.2 V to 3.6 V						
ICCB		VI = VCCI or GND	IO = 0	0 V	3.6 V						μΑ
				3.6 V	0 V						
ICCA	+ ICCB	$V_I = V_{CCI}$ or GND	IO = 0	1.2 V to 3.6 V	1.2 V to 3.6 V						μΑ
Ci	Control inputs	V <sub>I</sub> = 3.3 V or GND		3.3 V	3.3 V						pF
C <sub>io</sub>	A or B ports	V <sub>O</sub> = 3.3 V or GND		3.3 V	3.3 V						pF

NOTES: 10.  $V_{\mbox{CCO}}$  is the  $V_{\mbox{CC}}$  associated with the output port.

11. V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.



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# switching characteristics over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (see Figure 11)

242445752	FROM	то	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = 1.5 V	V <sub>CCB</sub> = 1.8 V	V <sub>CCB</sub> = 2.5 V	V <sub>CCB</sub> = 3.3 V		
PARAMETER	(INPUT)	(OUTPUT)	TYP	TYP	TYP	TYP	TYP	UNIT	
t <sub>PLH</sub>	۸	В						20	
<sup>t</sup> PHL	Α	Б						ns	
<sup>t</sup> PLH	В	А						20	
t <sub>PHL</sub>	Б	А						ns	
<sup>t</sup> PZH	ŌĒ	А							
t <sub>PZL</sub>	OE	А						ns	
<sup>t</sup> PZH	ŌĒ	В							
t <sub>PZL</sub>	OE	Б						ns	
<sup>t</sup> PHZ	ŌĒ	٨						20	
t <sub>PLZ</sub>	OE	Α						ns	
<sup>t</sup> PHZ	<u></u>	ь						nc	
t <sub>PLZ</sub>	ŌĒ	DE B	В _						ns

# switching characteristics over recommended operating free-air temperature range, $V_{CCA}$ = 1.5 V $\pm$ 0.1 V (see Figure 11)

PARAMETER	FROM (INPUT)	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.7	= 1.5 V I V	V <sub>CCB</sub> = ± 0.1	= 1.8 V 5 V	V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.3	3.3 V 3 V	UNIT
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	А	В										
<sup>t</sup> PHL	А	Б										ns
<sup>t</sup> PLH	В	А										
<sup>t</sup> PHL	Б	A										ns
<sup>t</sup> PZH	ŌĒ	А										20
t <sub>PZL</sub>	OE	А										ns
<sup>t</sup> PZH	OE	В										20
t <sub>PZL</sub>	OE	Б										ns
<sup>t</sup> PHZ	ŌĒ											
t <sub>PLZ</sub>	OE	Α										ns
<sup>t</sup> PHZ	OE	В	·									ns
tPLZ	OE .	ь										115

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# switching characteristics over recommended operating free-air temperature range, $V_{CCA}$ = 1.8 V $\pm$ 0.15 V (see Figure 11)

PARAMETER	FROM (INPUT)	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> =		V <sub>CCB</sub> = 1.8 V ± 0.15 V		V <sub>CCB</sub> = 2.5 V ± 0.2 V		V <sub>CCB</sub> = 3.3 V ± 0.3 V		UNIT	
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t <sub>PLH</sub>	Α	В										20	
<sup>t</sup> PHL	A	Ь										ns	
t <sub>PLH</sub>	В	۸										20	
t <sub>PHL</sub>	D	А										ns	
<sup>t</sup> PZH	ŌĒ	А											
t <sub>PZL</sub>	OE	A										ns	
<sup>t</sup> PZH	ŌE	В										20	
t <sub>PZL</sub>	OE	В										ns	
<sup>t</sup> PHZ	ŌĒ	А										20	
t <sub>PLZ</sub>	OE	A										ns	
<sup>t</sup> PHZ	ŌĒ	В									·	ns	
t <sub>PLZ</sub>	OE											110	

# switching characteristics over recommended operating free-air temperature range, $V_{CCA}$ = 2.5 V $\pm$ 0.2 V (see Figure 11)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.7	= 1.5 V I V	V <sub>CCB</sub> = ± 0.1	= 1.8 V 5 V	V <sub>CCB</sub> = ± 0.		V <sub>CCB</sub> = ± 0.3		UNIT
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	А	В										20
<sup>t</sup> PHL	А	Ь										ns
<sup>t</sup> PLH	В	۸										20
t <sub>PHL</sub>	В	Α										ns
<sup>t</sup> PZH	ŌĒ	^										
tPZL	OE	Α										ns
<sup>t</sup> PZH	ŌĒ	В										20
tPZL	OE	Ь										ns
<sup>t</sup> PHZ	ŌĒ	А										20
t <sub>PLZ</sub>	OE	А										ns
<sup>t</sup> PHZ	OE.	ŌE B									·	ns
tPLZ	OE .	ъ									·	115

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# switching characteristics over recommended operating free-air temperature range, $V_{CCA}$ = 3.3 V $\pm$ 0.3 V (see Figure 11)

PARAMETER	FROM	TO	V <sub>CCB</sub> = 1.2 V	V <sub>CCB</sub> = ± 0.7		V <sub>CCB</sub> = ± 0.1		V <sub>CCB</sub> = ± 0.2		V <sub>CCB</sub> = ± 0.3		UNIT	
	(INPUT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t <sub>PLH</sub>	А	В										20	
<sup>t</sup> PHL	А	Б										ns	
t <sub>PLH</sub>	В	А										20	
t <sub>PHL</sub>	D	А										ns	
<sup>t</sup> PZH	ŌĒ	А										20	
t <sub>PZL</sub>	OE	А										ns	
<sup>t</sup> PZH	ŌĒ	В										20	
t <sub>PZL</sub>	OE	В										ns	
<sup>t</sup> PHZ	<u>OE</u>	А										20	
t <sub>PLZ</sub>	OE	A										ns	
t <sub>PHZ</sub>	ŌĒ	В										ns	
t <sub>PLZ</sub>	OE	, B										115	

## operating characteristics, T<sub>A</sub> = 25°C

F	PARAMET	ER	TEST CONDITIONS	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.2 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.5 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 1.8 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 2.5 V	V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V	UNIT
			CONDITIONS	TYP	TYP	TYP	TYP	TYP	
	A to D	Outputs Enabled							
Ct	A to B	Outputs Disabled	C <sub>L</sub> = 0, f = 10 MHz,						
C <sub>pdA</sub> †	D to A	Outputs Enabled	$t_r = t_f = 1 \text{ ns}$						pF
	B to A	Outputs Disabled							
	A to B	Outputs Enabled							
C int	A to B	Outputs Disabled	C <sub>L</sub> = 0,						, F
C <sub>pdB</sub> †	B to A	Outputs Enabled	$f = 10 \text{ MHz},$ $t_f = t_f = 1 \text{ ns}$						pF
		Outputs Disabled							

<sup>†</sup> Power-dissipation capacitance per transceiver



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#### power-up considerations

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up V<sub>CCA</sub>.
- 3. V<sub>CCB</sub> can be ramped up along with or after V<sub>CCA</sub>.

# typical total static power consumption ( $I_{CCA} + I_{CCB}$ )

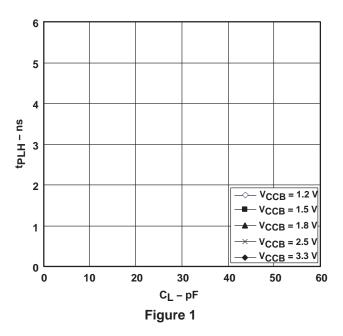
Vaca		VCCA									
VCCB	0 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	UNIT				
0 V											
1.2 V											
1.5 V											
1.8 V							μΑ				
2.5 V											
3.3 V											

TABLE 1

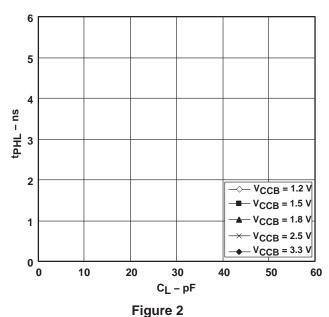


#### **TYPICAL CHARACTERISTICS**

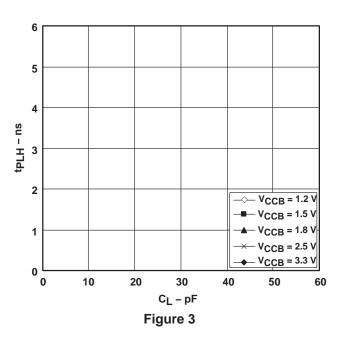
#### TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$ , $V_{CCA} = 1.2 \text{ V}$



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TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 1.5 \text{ V}$ 



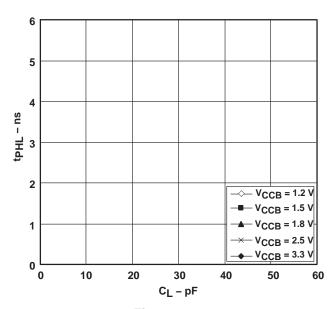
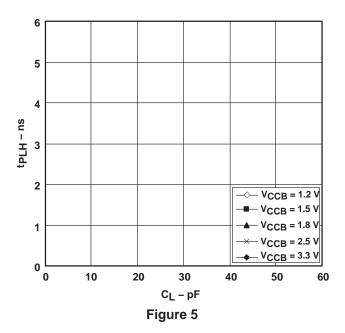
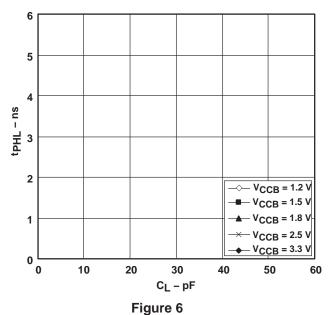


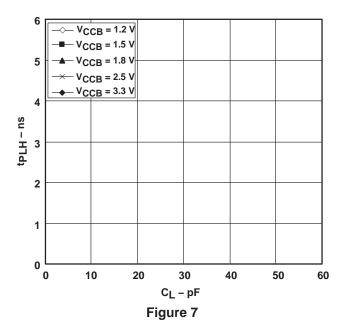
Figure 4

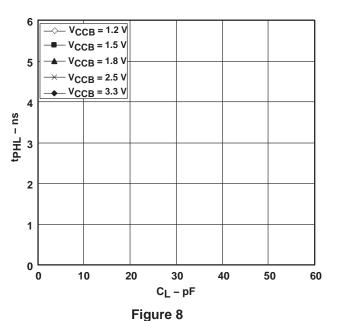
# TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$ , $V_{CCA} = 1.8 \text{ V}$



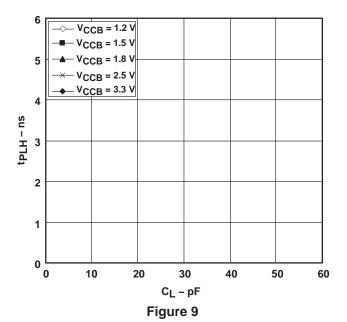


TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,  $T_A = 25^{\circ}C$ ,  $V_{CCA} = 2.5$  V





# TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$ , $V_{CCA} = 3.3 \text{ V}$



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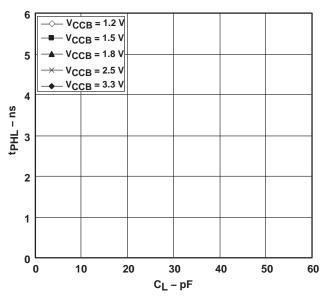
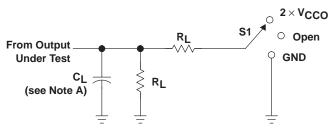


Figure 10

**VCCA** 

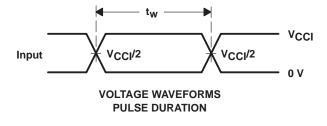
#### PARAMETER MEASUREMENT INFORMATION

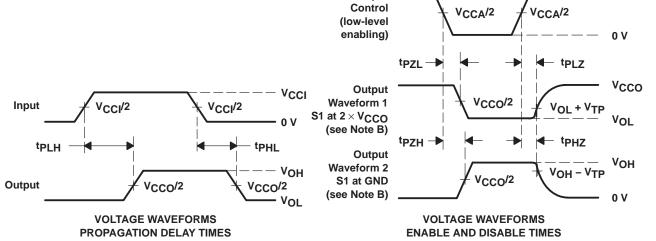


TEST	S1
t <sub>pd</sub>	Open
t <sub>PLZ</sub> /t <sub>PZL</sub>	2×V <sub>CCO</sub>
tPHZ/tPZH	GND

**LOAD CIRCUIT** 

Vcco	CL	RL	V <sub>TP</sub>
1.2 V	15 pF	<b>2 k</b> Ω	0.1 V
1.5 V $\pm$ 0.1 V	15 pF	<b>2 k</b> Ω	0.1 V
1.8 V $\pm$ 0.15 V	15 pF	<b>2 k</b> Ω	0.15 V
2.5 V $\pm$ 0.2 V	15 pF	<b>2 k</b> Ω	0.15 V
3.3 V $\pm$ 0.3 V	15 pF	<b>2 k</b> Ω	0.3 V





Output

- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω, dv/dt ≥ 1 V/ns, dv/dt ≥ 1 V/ns.
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E. tpLz and tpHz are the same as tdis.
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G. tpLH and tpHL are the same as tpd.
  - H. V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.
  - I. VCCO is the VCC associated with the output port.

Figure 11. Load Circuit and Voltage Waveforms



#### DGV (R-PDSO-G\*\*)

#### 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

# D (R-PDSO-G16)

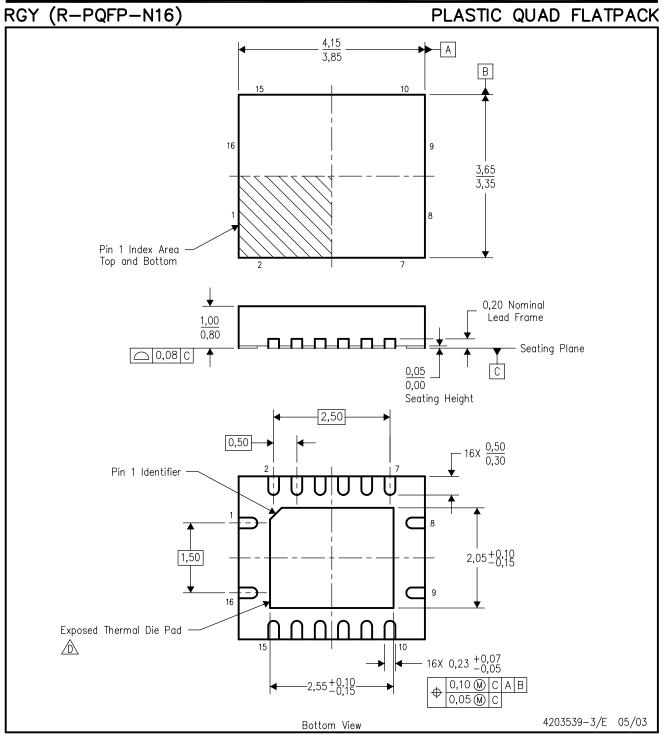
# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.





- NOTES: A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. QFN (Quad Flatpack No-Lead) package configuration.
  - The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane.

    This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
    - E. Package complies to JEDEC MO-241 variation BB.



#### DB (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

#### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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